

N-channel 30 V, 2.15 m Ω typ., 120 A Power MOSFET in a TO-220 package

Datasheet - production data

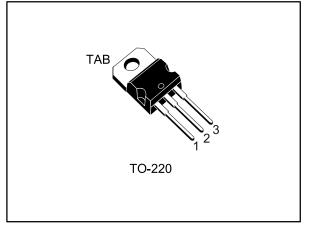
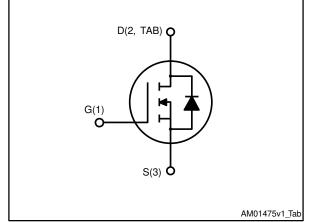


Figure 1: Internal schematic diagram



Features

Order code	V _{DS}	R _{DS(on)} max.	ID	Ρτοτ
STP200N3LL	30 V	2.4 mΩ	120 A	176.5 W

- Very low on-resistance
- Very low gate charge
- High avalanche ruggedness
- Low gate drive power loss

Applications

• Switching applications

Description

This device is an N-channel Power MOSFET with very low $R_{\text{DS}(\text{on})}$ in all packages.

Table 1: Device summary

Order code	Marking	Package	Packing
	inanting	i uokugo	i uokiig
STP200N3LL	200N3LL	TO-220	Tube

DocID028758 Rev 2

This is information on a product in full production.

Contents

Contents

1	Electric	cal ratings	3
2	Electric	cal characteristics	4
	2.1	Electrical characteristics (curves)	6
3	Test cir	rcuits	8
4	Packag	e information	9
	4.1	TO-220 type A package information	10
5	Revisio	on history	



1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit	
VDS	Drain-source voltage	30	v	
V_{GS}	Gate-source voltage ±20			
ID	Drain current (continuous) at T _{case} = 25 °C (silicon limited)	200		
ID ⁽¹⁾	Drain current (continuous) at T _{case} = 25 °C 120			
ID	Drain current (continuous) at T _{case} = 100 °C 120		A	
I _{DM} ⁽²⁾	Drain current (pulsed) 480			
Ртот	Total dissipation at $T_{case} = 25 \text{ °C}$ 176.5		W	
Eas ⁽³⁾	Single pulse avalanche energy	pulse avalanche energy 300		
T _{stg}	Storage temperature range		°C	
Tj	Operating junction temperature range	-55 to 175	-0	

Notes:

⁽¹⁾ Current is limited by package.

 $^{\left(2\right) }$ Pulse width is limited by safe operating area.

 $^{(3)}$ starting T_j = 25 °C, I_D = 68 A

Table 3: Thermal data

Symbol	Parameter	Value	Unit	
R _{thj-case}	Thermal resistance junction-case	0.85		
Rthj-amb	Thermal resistance junction-ambient	62.5	°C/W	



2 Electrical characteristics

(T_{case} = 25 °C unless otherwise specified)

Table 4: Static						
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	V_{GS} = 0 V, I_D = 1 mA	30			V
	Zava sata valtana dvain	V_{GS} = 0 V, V_{DS} = 30 V			1	
IDSS	Zero gate voltage drain current				10	μA
I _{GSS}	Gate-body leakage current	$V_{\text{DS}}=0~V,~V_{\text{GS}}=\pm20~V$			±100	nA
$V_{GS(th)}$	Gate threshold voltage	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1		2.5	V
R _{DS(on)} Static drain-sol resistance	Static drain-source on-	$V_{GS} = 10 V, I_D = 60 A$		2.15	2.4	
	resistance	$V_{GS} = 4.5 \text{ V}, I_D = 60 \text{ A}$		2.5	3.1	mΩ

Notes:

⁽¹⁾Defined by design, not subject to production test.

Symbol	Parameter	Test conditions		Тур.	Max.	Unit
Ciss	Input capacitance		-	5200	-	
Coss	Output capacitance	$V_{DS} = 25 \text{ V}, \text{ f} = 1 \text{ MHz}, \text{ V}_{GS} = 0 \text{ V}$	-	640	-	pF
Crss	Reverse transfer capacitance			510	-	
Qg	Total gate charge		-	53	-	
Q _{gs}	Gate-source charge	V_{DD} = 15 V, I_D = 120 A, V_{GS} = 4.5 V (see <i>Figure 14: "Test circuit for gate</i>	-	13	-	nC
Q _{gd}	Gate-drain charge	charge behavior')		27	-	
Rg	Intrinsic gate resistance	f = 1 MHz, I_D = 0 A, gate DC bias = 0 V, magnitude of alternative signal = 20 mV	-	1.1	-	Ω

Table 5: Dynamic

Table 6: Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
td(on)	Turn-on delay time	$V_{DD} = 15 \text{ V}, \text{ I}_{D} = 60 \text{ A } \text{R}_{G} = 4.7 \Omega,$	-	18	-	
tr	Rise time	V _{GS} = 10 V (see <i>Figure 13: "Test circuit</i>	-	183	-	
td(off)	Turn-off delay time	for resistive load switching times" and Figure 18: "Switching time waveform")	-	90	-	ns
tr	Fall time		-	108	-	



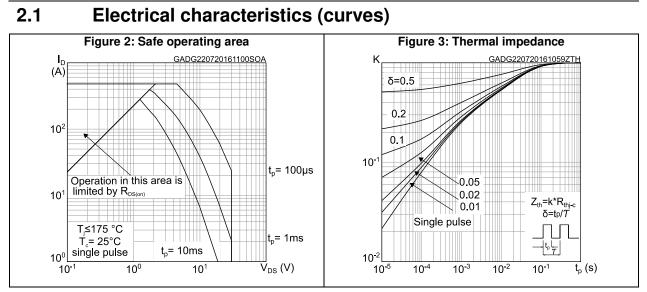
Electrical characteristics

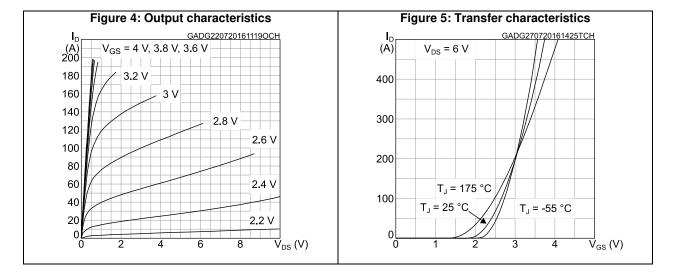
	Table 7: Source-drain diode					
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{SD} ⁽¹⁾	Forward on voltage	$V_{GS} = 0 V$, $I_{SD} = 60 A$	-		1.1	V
trr	Reverse recovery time	I _{SD} = 120 A, di/dt = 100 A/μs,	-	35		ns
Qrr	Reverse recovery charge	$V_{DD} = 24 V$ (see Figure 15: "Test circuit for inductive load switching	-	34		nC
I _{RRM}	Reverse recovery current	and diode recovery times")	-	2		А

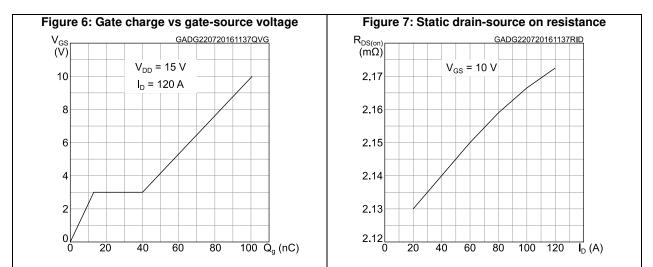
Notes:

 $^{(1)}$ Pulse test: pulse duration = 300 $\mu s,$ duty cycle 1.5%.







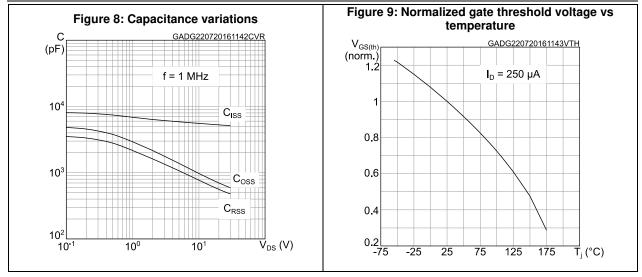


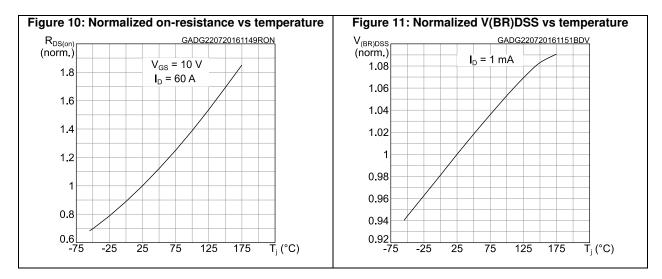
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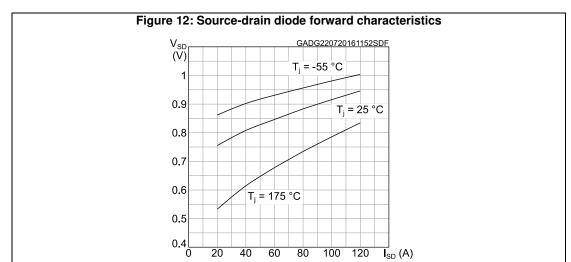


57

Electrical characteristics

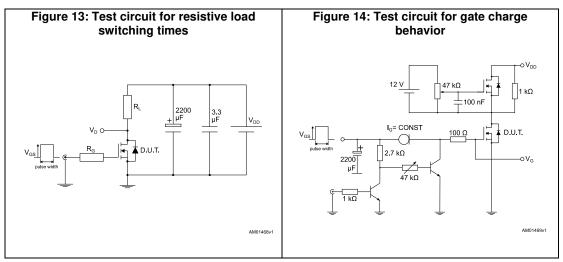


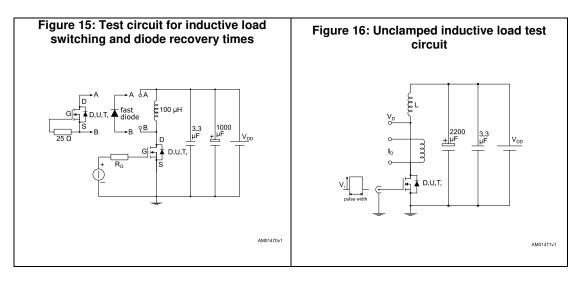


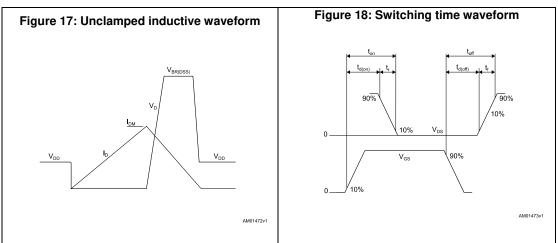


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3 Test circuits







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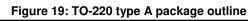


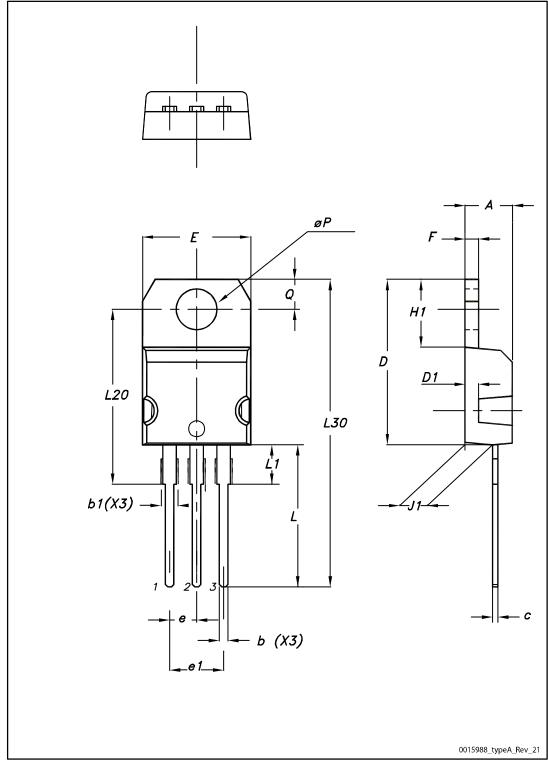
4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.











Package information

		Package information
Table 8: TO-220 typ	e A mechanical data	
	mm	
Min.	Тур.	Max.
4.40		4.60
0.61		0.88
1.14		1.55
0.48		0.70
15.25		15.75
	1.27	
10.00		10.40
2.40		2.70
4.95		5.15
1.23		1.32
6.20		6.60
2.40		2.72
13.00		14.00
3.50		3.93
	16.40	
	28.90	
3.75		3.85
2.65		2.95
	Min. 4.40 0.61 1.14 0.48 15.25 10.00 2.40 4.95 1.23 6.20 2.40 13.00 3.50 3.75	Min. Typ. 4.40



Revision history 5

Table 9: Document revision history

Date	Revision	Changes
14-Dec-2015	1	First release.
27-Jul-2016	2	Document status promoted from preliminary to production data. Updated Section 2: "Electrical ratings" and Section 3: "Electrical characteristics". Added Section 3.1: "Electrical characteristics (curves)". Minor text changes.



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